

<<材料科学与工程基础>>

图书基本信息

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作者 : 凯里斯特

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内容概要

该书具有很完整的材料与工程体系，无论作为材料专业的教材，还是科技书，都具有很强的实用价值。

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作者简介

作者 : (美国)凯里斯特

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